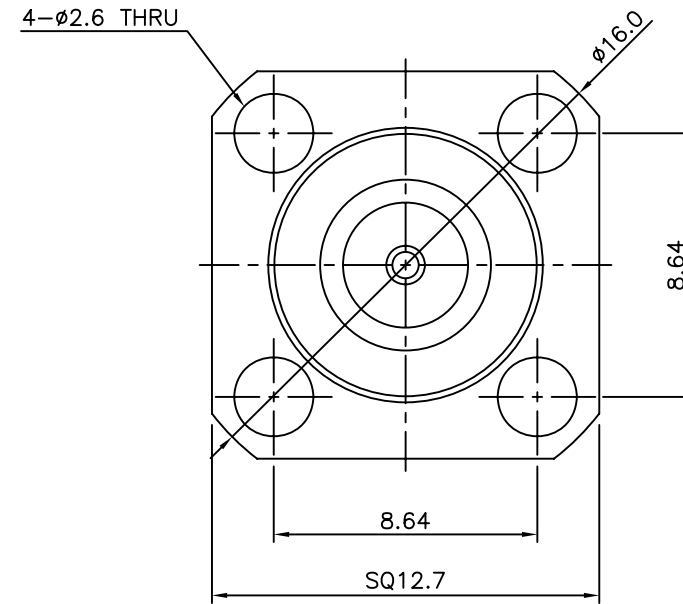
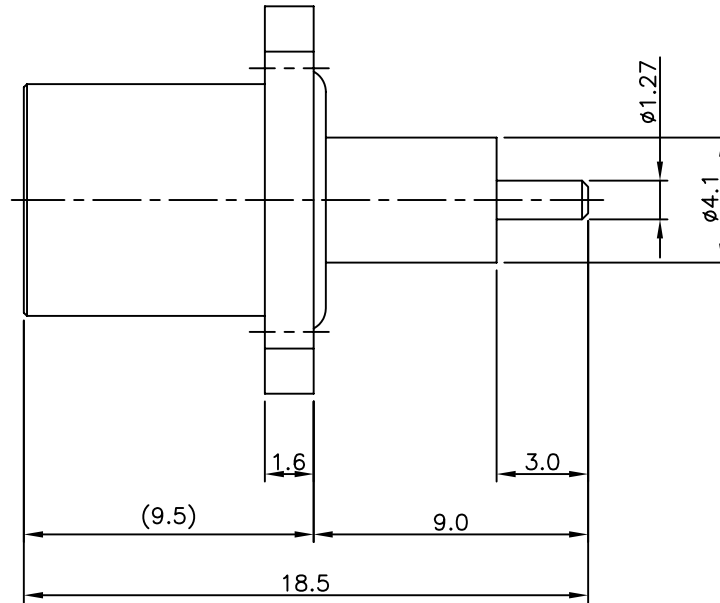


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1 R	Initial Registration	S.Y.EUN	I.C.KIM	2019.11.05.



6	GASKET	1	SILICONE	RED	DGK00020-N/1
5	PIN COVER	1	MBsBD C3604BD-F	Gold Plate	DIB00026-5/1
4	PLATE SPRING	1	BeCu C17300	Gold Plate	DPS00002-5/1
3	INSULATOR	1	TEFLON		DIN02355-N/4
2	CONTACT	1	BeCu C17300	Gold Plate	DCT03979-5/2
1	BODY	1	MBsBD C3604BD-F	Nickel Plate	DBD04446-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2019. 11. 05.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL	-	CHECKED BY		TITLE BMA50 SOLDER END JS-4H
		DRAWN BY	S.Y.EUN	
FINISH	-	SCALE	4/1	DWG NO. CN03127-7/2 REVISION I R SHEET 1 of 1
		UNIT	mm	